

IEEE Reliability Society

NEWSLETTER

Vol. 38, No. 1, January 1992 (USPS 460-200)

C O N T E N T S

Message from the President

1

Editor's Column

2

RS Society Officers

2

Reliability Forum

3

Chapter Activities

4

Conference Calendar

6

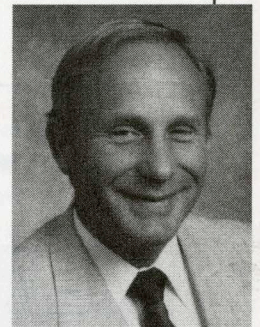
RS Chapter Chairmen

8

Editor:
Bruce Bream

Message from the President

I have received correspondence from some of you and I want you to know that it is good to hear from you. The Tokyo chapter recently held their first reliability symposium. They sent me a copy of their proceeding. I am proud of initiatives like this.



RAMS

I will be at the Reliability and Maintainability symposium in January in Las Vegas. I will have a paper to present and will be giving a tutorial on software reliability. The executive group of the reliability society will meet in an Adcom meeting. This will be held Monday afternoon prior to the commencement of the symposium. It will start at 1:00 pm and run till 5:00 pm. Any of you who want are welcome to join us. A meeting notice will be posted with the hotel events.

Publications

The reliability society has a close-in financial problem in this area and a long range plan. The close in financial problem comes from mailing all the conference proceedings to our members. The cost of mailing the transactions, newsletter, RAMS, and IRPS proceedings runs approximately \$55.00 per member. The compares to \$10.00 for 1992 dues (we do have significant off setting revenue from selling our transactions to non-members, such as libraries).

We plan to solve this in a way that will remain supportive of our members publications needs. We want to better deliver to each member the publications that member uses. In 1993, members can personalize their publication choices. A tailored set of publications will be provided with the members dues. The other publications will be attractively priced for those want all of them.

For 1992, we need to tailor our proceedings delivery in order to achieve a balanced budget. To this end, the reliability physics proceedings, IRPS, will be sent to our members who are receiving

(continued on page 5)

1253459 SM 07N ****
PAUL GOTTFRIED
9251 THREE OAKS DR
SILVER SPRING MD 20901
WTE13

Editor's Column

Our newsletter provides a place for the sharing of knowledge in our specialty, Reliability and Maintainability. I'm glad to see that we have something new to share with you this issue. You will find the new due date schedule gives us a couple more weeks to accept copy before presses. There are a number of new call for papers that have been received in the last quarter. The IEEE Technical Activities Board has a new video about planning successful meetings that is available to chapters. I encourage you to discover what is offered by the bulletin boards listed in our newsletter. The Statistics Bulletin Board has a number of programs available for download. Many are available in the source language to alleviate the concern over importing a computer virus. As I mentioned in October, we provide a means to exchange ideas. A new section "Reliability Forum" allows you to present your views on R&M topics. I received a letter from Kam Wong related to a paper he presented at the 1990 RAMS (90RM047). I encourage you to respond to the issue presented or write on another topic.

Bruce Bream
Editor, IEEE Reliability Society Newsletter

Reliability Society Newsletter Inputs

All RS newsletter inputs should be sent to:
Mr. Bruce Bream
NASA Lewis Research Center, M.S. 501-4
21000 Brookpark Road
Cleveland, OH 44135
Tel: (216) 433-6532 Fax: (216) 433-5270
Email: scbream@lims02.lerc.nasa.gov

The schedule for submittals is:

Newsletter	Due Date
January	November 19
April	February 20
July	May 21
October	August 20

Reliability Society Newsletter is published quarterly by the Reliability Society of the Institute of Electrical and Electronic Engineers, Inc. Headquarters: 345 East 47th Street, New York, NY 10017. Sent at a cost of \$1.00 per year to each member of the Reliability Society. Printed in U.S.A. Second class postage paid at New York, NY and at additional mailing offices. Postmaster: Send changes to Reliability Society Newsletter, IEEE, 445 Hoes Lane, Piscataway NJ 08854.

RELIABILITY SOCIETY OFFICERS

PRESIDENT

Dr. Samuel J. Keene
IBM
P.O. Box 9023
Dept. TR4 Bldg 003C
Boulder, CO 80301-9023
(303) 924-7711 FAX (303) 924-4752

VP TECHNICAL OPERATIONS

Mr. Joseph A. Gruessing
Westinghouse Electric
P.O. Box 726, M/S 1701
Baltimore, MD 21203
(301) 765-7070 FAX (301) 993-8126

VP PUBLICATIONS

Mr. Paul Gottfried
9251 Three Oaks Drive
Silver Spring, MD 20901
(301) 907-4028 FAX (301) 907-4308

VP MEMBERSHIP

Mr. Henry N. Hartt
Vitro Corp.
Suite 300 - West Wing
600 Maryland Avenue
Washington, DC 20024
(202) 646-6339 FAX (202) 646-6398

VP MEETINGS

Mr. Richard L. Doyle
Doyle and Associates
5677 Soledad Road
La Jolla, CA 92037
(619) 457-8914

JR. PAST CHAIRMAN

Mr. Bernhard A. Bang
Westinghouse Elec.
P. O. Box 1521, MS 3G07
Baltimore, MD 21203
(301) 765-7340 FAX (301) 765-5070

SECRETARY

Mr. Robert Jaquess
Martin Marietta
P.O. Box 179, M/S L5461
Denver, CO 80201
(303) 971-4221

TREASURER

Dr. Richard A. Kowalski
ARINC Research Corporation
2551 Riva Road
Annapolis, MD 21401
(301) 266-4841 FAX (301) 266-4049

Reliability Forum

The Exponential Law

The year was 1954. A paper was presented at the IRE Annual Meeting in New York showing mathematically that under a continuous replacement-upon-failure procedure, the long term steady-state failure rate of a system containing a group of parts having the same failure density function is a constant. This assertion holds true for any failure density distribution, Gaussian or otherwise. At steady-state, the age distribution of the parts in the system has the shape of one minus the cumulative failure distribution. This mathematical proof further strengthened the Exponential Law being touted as the law governing the failure characteristics of electronics. Sorry to say that I was a co-author of that paper as later on I realized that very few, if any, electronic equipment ever reach steady-state. In most cases the mission time is not long enough to ensure the mixing of failures to result in a random process. At that time I was also collecting failure data on a group of computers. Soon after 1954 I had enough data to plot a curve of sub-miniature electron tube failure rate versus tube age for the first thousand hours of operation. One thousand hours was almost reaching the end of life for the sub-miniature tubes. The curve showed a slight downward slope indicating that the failure rate was decreasing. Since it was a slight slope I attributed it to statistical variation.

After my exposure to the Exponential Law I was troubled by the lack of physical basis for the existence of that law. When I started to investigate failures data after environmental stress screening, I found that the concept of the Exponential Law simply did not fit in. Then I began to look at failure data related to equipment and part ages. It turned out that some data generated as far back as 1961 showed complete non-conformance to the Exponential Law. The best data was collected by Pettinato and McLaughlin on the testing of 20 sets of AVR-200 transistorized communication sets. They presented a paper on the findings at the 1961 National Symposium of Reliability

This section provides a means for members to express their views on R&M topics of interest to the entire R&M community. Contributions are welcomed by the editor. Authors may send letters either by mail or Email. A daytime phone and complete mailing address must be provided. RSNL reserves the right to edit the content of letters received.

and Quality. Based on that set of data I plotted the failure rate curves that clearly show the failure rates were not constant. Other analyses on failure data for satellites and microcircuits have shown a decreasing failure rate.

Until a few years ago I had been more or less going along with the majority of the reliability practitioners using the Exponential Law primarily because the workplace inertia made the

Exponential Law paradigm too hard to change. I think now is the time to make some changes. How about you? The readers of this Newsletter would like to hear from you.

If you would like to talk about this subject feel free to contact me, Kam L. Wong (Mr.), Kambea Industries, 1130 Ronda Drive, Manhattan Beach, CA, 90266, U.S.A., Tel: (213)372-4533.

Kam L. Wong

RELIABILITY BOOKSHELF

RELIABILITY ENGINEERING HANDBOOK, Vol. 1 and Vol. 2
Dimitri Kececioglu, PhD, P.E.
Department of Aerospace and Mechanical Engineering
The University of Arizona
ISBN 0-13-772294-X (v. 1)
ISBN 0-13-772302-4 (v. 2)
Prentice Hall
Englewood Cliffs, NJ 07632
1991

This two volume set is a collection of works from Dimitri's development and teaching of the University of Arizona Reliability Engineering Pro-

gram. It is written for use as a text for introductory reliability courses. It serves this purpose well since it is filled with a good mix of worked examples, use of distributions, and equation derivations. The combination of these contributes to the need for two volumes. Although the index in each book is not as complete as would be expected, the detailed contents pages are a good place to look for topics. The first volume mostly deals with data and distributions while volume two mostly deals with system analysis issues.

Chapter Activities

IDEAS FOR MEETINGS

Have you thought of renting a video for your next meeting? Videotapes are available from a couple of sources. Our Los Angeles section has a tremendous video library on Engineering and R&M topics. The index can even be viewed on their electronic bulletin board. The IEEE Technical Activities Board (TAB) also has videos available for loan at no charge to IEEE chapters. One of these is "Planning Successful Chapter Meetings". This video outlines the basics of putting together an interesting and well attended meeting. It includes information on selecting a subject and format, finding good speakers, planning social aspects of the meeting and publicity. For information on this TAB video call Alicia Tomaszewski at (908)562-3905.

Boston

The Boston Section is having a successful year to date. The October monthly meeting held at the Hanscom Air Force Base NCO club on October 9th was well attended as we all listened to Mike Kozell from Data General speak on ESS. This session like the others was well attended by our membership.

The Fall Lecture series on "Software Reliability Measurement, and Modeling" authored by Drs. Michael Elbert and David Heimann was well received. The lectures were held at GTE labs and was highly successful. Our special thanks to GTE labs for allowing the lecture series to be held on their premises. We are in the planning stages for our Spring Lecture series on Stress Screening to be held in March and April.

Regards,

Gary Kushner
Boston Chapter Chairperson

Cleveland

The Cleveland Chapter has had two good meetings. Our first meeting was on careers and educational resources. This meeting was in celebration of NASA Lewis Research Center's 50th anniversary. The auditorium at the Visitor's Center showed 140 younger people are interested in career development. The importance of education and training was explained very nicely by Lewis Speaker Bureau member Sandra M. Walters. Our second meeting was on Software Testing and Reliability. This meeting was from the IEEE Learning Channel Videoconference Seminars via satellite. Our chapter has worked on a special project for the 1992 RAMS. Ten members (J. Reagan, C. Yeh, E. Zampino, D. Hoffman, B. Bream, J. Dorsey, J. Lyons, D. Garman, E. Sprague and V. Lalli) graded 184 papers for the Technical Program Committee. We organized 2 sessions: 3C-Design Practices and 6C-Future Role of R&M Assurance in Space Flight Exploration. Thanks a lot for your help. All-in-all here in Cleveland we are having fun serving

our members and look forward to expanded activities in the future.

Sincerely,

Vince Lalli
Chairman, Cleveland Chapter

Dallas

The Dallas IEEE Reliability Society Chapter was founded in 1989 by Louis Boudreaux and has grown in many ways. Lou is an employee of Texas Instruments, Defense Systems and Electronics Group. He sensed a need from fellow employees and others in the reliability technical community for a forum to achieve the following: a) communications among technologists in this field, b) an opportunity to network with others working this technology in the local community, and c) a vehicle for technology updates.

This year the local Dallas chapter got it's first set of new administrators. Louis had been the presiding officer for three years. Dennis Hoffman progressed from vice-chairperson to chairperson, thus turning over a new leaf in the history of the Dallas organization. Lou's efforts are much appreciated. Without his drive the Dallas chapter would not exist. Every new organization needs a leader with a lot of vitality and energy to make it happen and keep it fueled for the first several years. Lou was recognized at the IEEE Dallas section banquet by the IEEE Reliability Society local chapter for his outstanding service and dedication. Lou has set a fine example of voluntary leadership.

The toughest challenge of the organization has primarily fallen to the membership committee leader. As you may have found in your chapters, typically one company in the local area participates in the majority. Our challenge has been to get multi-company and joint-society participation. Multi-company participation is a challenge because not all companies encourage professional society participation and demands on personal time are great. We have worked membership drives through varying our meeting content broadly, mailing out an-

nouncements to key individuals outside the primary company that participates and 'cold calling' local companies for names of interested parties. The solution that seems to work is targeting the meetings and speakers to serve the audience.

An equally challenging task is managing the variety and scope of the programs. The program committee leader uses inputs from many members to form the roster of speakers each year. Mid-course adjustments may have to be made to the program plans as opportunities arise such as potential speakers visiting industry in our area. We take advantage of a broad spectrum of speakers from industry, government, and academia.

If you are working in the reliability or maintainability field in the Dallas metroplex area, please get involved with your local chapter. We're here to serve you!

Julie England
Dallas Chapter Vice-Chairperson

Los Angeles

The Los Angeles Chapter had three technical meetings during the last couple of months:

In July, Rudy Marloth of Hughes Aircraft lectured on the latest development of Synthetic Array Radar System (ASARS). Rudy currently works on ASARS and showed actual photos generated by the system.

In August, Bill Zeller of Hughes Aircraft discussed the survey of the field of brain machines. The purposes and benefits were discussed.

In September, we held a joint meeting with the LA Chapter of the SSIT and the Power Society. Two speakers from Southern California Edison discussed Alternate Energy Sources and Low Frequency EM Fields. The first speaker was Ron Luxa and discussed various forms of energy. The second speaker was Norm

DeHaven and he discussed the dangers and/or safety of EM Fields.

Upcoming meetings include:

In October, a speaker from Anamarctic will be speaking on the latest developments of Wafer Scale Integration.

In November, Dave Franklin of Hughes Aircraft will discuss Failure Analysis and Risk Assessment.

Our Bulletin Board is very active with over 400 subscribed members. Membership is free. We offer meeting information, Jobline, E-Mail, Videotape Exchange Information, Shareware and Demos. Phone is (818) 768-7644, 300-2400 baud.

Our Videotape Exchange program continues to be popular. Currently we have over 100 videotapes available. Information on the latest can be viewed and downloaded through our bulletin board.

Loretta Arellano
Los Angeles Chapter Chair

Mohawk Valley

We are hosting our second annual conference in June 1992. The theme of this years conference is Command, Control, Communications, and Intelligence (C3I) Technology. A session on Quality and Reliability will be included.

Charles Messenger
Chairman

Washington/ North Virginia

Our chapter completed another successful year culminating in a third place in the National section activities contest. We're looking forward to another great year with several tours and a series of excellent speakers.

Terry Logee
Chairman

Message from the President

(continued from front cover)

the semiconductor manufacturing transactions. That is approximately 1200 members. The remaining 2800 members will be sent the RAMS proceedings. We believe this will best satisfy your desires in a cost effective manner. If this arrangement is a severe inconvenience, please contact Paul Gottfried and we will try to accommodate your needs.

We apologize for any inconvenience to you by this action. Our reserves had dropped dangerously low and some action was deemed imperative. We hope in the future to better meet you publication needs, in a cost effective manner, without routinely mailing you things you don't care about.

Sincerely,

Dr. Samuel J. Keene
President, Reliability Society

Electronic Bulletin Boards

Los Angeles Chapter
(818) 768-7644
300-2400 Baud (8N1)

Free Membership
(400+ members)

Meeting information, Jobline,
Email, Video Tape Exchange Information,
Shareware and Demos

Statistics Bulletin Board System
(316) 265-3036
1200-2400 Baud (8N1)

Free Membership

Statistics, Reliability

Conference Calendar

DATE	CONFERENCE	PLACE
------	------------	-------

1992

Jan 21-23	1992 Annual Reliability and Maintainability Symposium	Las Vegas, NV
-----------	---	---------------

Contact: Dr. R.J. Lumas, Lockheed Space Operations, MS LSO 291, 110 Lockheed Way, Titusville, FL 32780, Tel: (407) 867-5921 Fax: (407) 867-2131

Feb 3-5	SEMI-THERM Thermal characterization of devices, components, and systems, reliability screening and testing	Austin, TX
---------	---	------------

Contact: Mr. Bob Simons, IBM Corporation, Dept. b02, Building 701, Poughkeepsie, NY 12602, Tel: (914) 435-1650 Fax: (914) 432-9805

Mar 30-Apr 2	1992 International Reliability Physics Symposium	San Diego, CA
--------------	--	---------------

Contact: **USA:** Harry A. Schafft, General Chairman, 1992 IRPS NIST, Bldg. 225, Rm. B360, Gaithersburg, MD 20899 Tel: (301)975-2234 Fax: (301)948-4081
Asia: Dr. Eiji Takeda, IRPS Puplicity Committee Hitachi Ltd., P.O. Box 2, Kokubunji, Tokyo 185, Japan Tel: (81) 423-23-1111 x3325 Fax: (81) 423-27-7699
Europe: Dr. Wolfgang Gerling, IRPS Puplicity Committee Siemens AG, Balanstr. 73, D-8000 Munich 80, Germany Tel: (49) 89 4144-2825 Fax: (49) 89 4144-3828

April 23	30th Annual All-Day Seminar Reliability Engineering: Alternative Techniques for Today's Business Environment	Boston, MA
----------	---	------------

Contact: Jim Kalemba, 6 Ohio Road, Tyngsboro, MA 01879-2365

May 18-20	42nd Electronic Components & Technology Conference	San Diego, CA
-----------	--	---------------

Contact: Iwona Turlik, Microelectronics Center of N.C., 3021 Cornwallis Road, Research Triangle Park, NC 27709 Tel: (919) 248-1847 Fax: (919) 248-1455

Jun 10-12	European Safety and Reliability 92	Copenhagen, Denmark
-----------	------------------------------------	---------------------

Contact: Kurt Petersen, Systems Analysis Dept. RISO National Laboratory, PO Box 49, DK-4000 Roskilde, Denmark Tel: (45) 42 37 12 12 x3082 Fax: (45) 46 75 71 01

CALLS FOR PAPERS

1992

May 3-6	Custom Integrated Circuits Conference	Boston, MA
---------	---------------------------------------	------------

Abstracts due November 7, 1991

Contact: Mrs. Roberta Kaspar, Technical Program Coordinator, CICC '92 1597 Ridge Road West, Suite 101C, Rochester, NY 14615-2514 Tel: (716) 865-7164

Jun 15-18	COMPASS - 7th Annual Conference on Computer Assurance	Gaithersburg, MD
-----------	---	------------------

Authors requested to send five single-sided copies of their papers (not exceeding 7,500 words) to the program chair by January 10, 1992. Acceptance notification will be by March 7, 1992 with camera-ready papers due April 1, 1992.

Conference Information: Robert Ayers, ARINC Research Corporation, 2551 Riva Road, Annapolis, MD 21401, Tel: (301)266-4741, Fax: (301)266-4040

Program Chair: Dr. Edgar H. Sibley, Dept. of Information & Software Systems Engineering, George Mason University 4400 University Drive, Fairfax, VA 22030-4444, Tel: (703)993-1640, Email: esibley@gmuvax.gmu.edu

(Editor's note: Papers will be accepted past the January 10 deadline.)

Aug. 25-28	International Reliability Availability Maintainability Conference for the Electric Power Industry	Philadelphia, PA
------------	---	------------------

Papers are solicited on generation, transmission, and distribution, including application, modeling, design, and manufacture.

Prospective authors should submit 300-500 word abstracts by February 15, 1992. Authors will be notified of acceptance by March 15. Completed papers will be due by April 15, 1992.

Send abstracts to: Mr. Dev Raheja, Technology Management Inc., 9811 Mallard Drive, Suite 213, Laurel, MD 20708, Tel: (301)792-0710

Program Information: Mr. Bob Filipovits, Pennsylvania Power & Light, 1005 Brookside Road, Allentown, PA 18106, Tel: (215)398-5158

Oct 7-9	3rd International Symposium on Software Reliability Engineering	Research Triangle Park, NC
---------	---	----------------------------

Papers due March 1, 1992

Contact: John C. Munson, Division of Computer Science, University of West Florida, Pensacola, FL 32514, Tel: (904) 474-2989 jmunson@dcs119.dcsnod.uwf.edu

1992	IEEE Transactions on Reliability Special Issue on Fault-Tolerant Software
------	---

(See full page description in this issue of RSNL)

1993

Sep 29-Oct 1	16th International Symposium on Computer Performance Modeling, Measurement and Evaluation	Rome, Italy
--------------	---	-------------

Contact: **North America:** Dr. Stephen S. Lavenberg IBM T.J. Watson Research Ctr., P.O. Box 704, Yorktown Heights, NY 10598, Tel: (914) 784-7573
Europe & Others: Prof. Giuseppe Iazeolla, University of Rome II, Electronic Engineering Dept., Viale della Ricerca Scientifica, 1-00173 - Roma - Italy, Tel: 39-6-79794486

RELIABILITY SOCIETY CHAPTER CHAIRMEN

ALBUQUERQUE

Mr. G. Barry Hembree, MS 25
The BDM Corp.
1801 Randolph Road, S.E.
Albuquerque, NM 87106
Tel: (505) 848-5719

BALTIMORE

Neville Jacobs
10 Calypso Court
Pikesville, MD 21209
(301) 992-3811 WK

BINGHAMTON

Thomas D. Gaska
1010 Elmwood Drive
Endwell, NY 13760

BOSTON

Gary Kushner
499 Brigham Street
Marlboro, MA 01752
Tel: (508)467-6765
Fax: (508)467-6796

CHICAGO

Daniel J. Glab
6454 No. Nashville Ave.
Chicago, IL 60631-2049
Office: (708)520-4405
Home: (312)763-7543

CLEVELAND

V. R. Lalli
NASA LRC
21000 Brookpark Road
MS 501-4
Cleveland, OH 44135
(216) 433-2354 WK
(216) 433-5270 FX

DALLAS

Dennis Hoffman
Texas Instruments
2553 Summit Ave.
P.O. Box 660246
Mail Stop 8290
Plano, TX 75074
Tel: (214)578-5814
Fax: (216)578-3705

DAYTONA/CANAVERAL

Frank J. Moreno
The Terrances
3209 Winnipeg Court
Melbourne, FL 32935

DENVER

Juan Hernandez
National Systems & Research
3075 Squaw Valley
Colorado Springs, CO 80918

FLORIDA WEST COAST

N/A

LOS ANGELES COUNCIL

Loretta Arellano
10940 Olinda St.
Sun Valley, CA 91352
Tel: (213) 578-4395

MOHAWK VALLEY

Charles G. Messenger
Rome Laboratory
RL/ERDA
Griffiss AFB, NY 13441-5700
Tel: (315) 330-2047
Email: messenger@rl.af.mil

MONTREAL

Michael B. Fortier
Bell Northern Research
INRS-Telecom/3 Place Du Commer
Ile-Des-Soeurs Que, Canada H3E 1H6
Tel: (514)765-7822

NEW YORK/LONG ISLAND

Vic Bonardi
Grumman Aerospace Co., B85-01
Bethpage, NY 11714
(516) 346-9598 (WK)

NORTHERN NEW JERSEY

Henry Moss
Kearfott Guidance & Navigation
Bldg 12 12B71
150 Totowa Road
Wayne NJ 07474

OTTAWA/ONTARIO

Rejean Arseneau
Nat'l Res. Council of Canada
Division of Electrical Engineering
Montreal Rd., Bldg M-50
Ottawa, Ontario, Canada,
K1A 0R8
Tel: (613)933-2660

PHILADELPHIA

Fulvio E. Oliveto
920 Snyder Ave.
Philadelphia, PA 19148
(609) 722-3147 WK

SANTA CLARA VALLEY/ SAN FRANCISCO/ OAKLAND/EAST BAY

Art Rawers
390 Chargin Way
Morgan Hill, CA 95037
Tel: (408)434-1410

SWITZERLAND

Prof. Alessandro Birolini
Reliability Laboratory
ETH-Zentrum
CH-8092 Zurich
Switzerland
Tel +41 (1) 256-5148
Fax +41 (1) 251-2172

TOKYO

Prof. Masayoshi Furuya
Dept. of Systems Engineering
Tokyo Denki University
Hatoyama, Saitama 350-03
Japan

TRI CITIES

Pete Montague
105 Travelers Way
Bristol, TN 37620

TWIN CITIES

Ron Hansen
VTC Inc.
2800 E. Old Shakopee Rd.
Bloomington, MN 55425-1350
Tel: (612)853-3529
Fax: (612)853-3355

WASHINGTON/ NORTHERN VIRGINIA

Terry Logee
VITRO Corporation
600 Maryland Avenue, SW
Suite 300W
Washington, DC 20024-2520
Tel: (202)646-6337
Fax: (202)646-6398

1992

Annual RELIABILITY AND MAINTAINABILITY Symposium

1992 January 21-23

1992

Riviera Hotel

1992

Las Vegas, Nevada USA

Assurance Technologies – Discovering New Horizons

Share your knowledge and expertise with your colleagues
at the world's premiere forum for the assurance technologies.

Telecomputing, industrial globalization, technology transfer, and multinational joint ventures are just a few of the activities which will be accelerated in the new world economy. Corporate as well as governmental procurements and R&D decisions in a world economy will be significantly influenced by issues such as best value, market share, concurrent engineering, and product quality. The assurance technologies must be prepared to adapt to this changing competitive environment. The development of pioneering assurance techniques or modification of proven ones must address cost-effective solutions to meet these contemporary challenges. To encourage your colleagues to expand their horizons, your paper should advance our knowledge of pioneering assurance methods or enhance our understanding of established techniques. Papers stressing application to real-world challenges will receive priority consideration. Papers in the following categories or types of subjects are solicited:

TECHNOLOGY

CAD/CAM/CAT/CALS
Design to Life-Cycle Cost
Modeling & Simulation Methods
Software Tools: R&M and Safety
R&M Test & Demonstration
Reliability Growth
Screening and Failure Analysis
FMEA and FMHEA
Built-In-Test & Testability
Worst-Case Analysis and
Prediction
Fault Trees & Diagramming
Techniques
Repair/Maintenance
Methodologies
R&M Cost-Benefit Analyses
Software Safety and R&M
Environmental Testing
Sneak Circuit Analysis

MANAGEMENT

CAD/CAM/CAT/CALS
Design to Life-Cycle Cost
System Effectiveness
R&M Contracting Management
R&M Requirements
Trend Analysis and Risk
Management
Database Management
R&M Cost-Benefit Tradeoffs
Testing Effectiveness
Warranties/Guarantees
Logistics Support
Multinational & International
Programs
Reliability-Growth Management
Product-Assurance Management
Safety Management
Training and Education

INDUSTRY APPLICATIONS AND LESSONS LEARNED

Aerospace & Defense
Electric Power & Other Utilities
Oil & Other Resource Industries
Mechanical/Structures Equipment
Transportation Methods and
Systems
Microelectronics
Computer Hardware & Peripherals
Software and Smartware
Robotics and Artificial Intelligence
Consumer Products
Medical and Biotechnology
Communication Systems
Office Automation & Database
Systems
Electrical & Electronic Systems
Telecomputing and Networks
Chemical and Agrichemical
Systems

The P.K. McElroy Award

The P.K. McElroy Award recognizes the best combination of the technical paper and its presentation. All submitted papers are graded by the Program Committee. The top contenders are selected and their presentations at the *Symposium* are monitored by a group of past General Chairman. The author(s) of the winning paper is recognized at the next *Symposium* and receives a plaque, a \$1000 honorarium, and gratis registration.

RAMS is a nonprofit symposium sponsored by the following Societies:

ASQC ■ IIE ■ IEEE ■ SOLE ■ IES ■ AIAA ■ SSS ■ SRE

For contact information see Conference Calendar.



CALL FOR PAPERS

Seventh Annual Conference on Computer Assurance

The Seventh Annual Conference on Computer Assurance (COMPASS), sponsored by the Institute of Electrical and Electronic Engineers and IEEE Aerospace and Electronic Systems Society, in cooperation with the British Computer Society, will be held at the National Institute for Standards and Technology in Gaithersburg, Maryland, USA, June 15-18, 1992. The purpose of this conference is to bridge the gap between emerging technology for computer assurance from research laboratories into industrial computer systems development. Papers may present original research on theoretical aspects and applications of technology to assured computing, or may be reports detailing experiments, evaluations, and open problems in the use of new technologies for computer assurance. Typical but not exclusive topics of interest include:

- Models and modelling (process, mathematical, and requirements models)
- Formal approaches (proofs of correspondence, formal specifications, and IV&V)
- Experiences with assurance (illustrative examples from communications, energy, financial, medical, military, transportation, and other types of systems)

PAPER SUBMISSION:

Authors are requested to send five single-sided copies of their papers (not exceeding 7,500 words) to the program chair by **January 10, 1992**. If available, an electronic mail address for the contact author should be included. Papers submitted simultaneously to another conference with published proceedings are disqualified. Papers will be refereed by the Program Committee and will be returned with comments. Accepted papers will be published in the proceedings.

IMPORTANT DATES:

Papers due:	January 10, 1992
Notification of acceptance:	March 7, 1992
Camera-ready paper due:	April 1, 1992
Conference:	June 15-18, 1992

Additional information about the COMPASS '92 can be obtained from the General Chair. All inquiries concerning paper submissions should be addressed to the Program Chair.

GENERAL CHAIR:

Robert Ayers
ARINC Research Corporation
2551 Riva Road
Annapolis, MD 21401 USA
voice: (301)266-4741
fax: (301)266-4040

PROGRAM CHAIR:

Dr. Edgar H. Sibley
Department of Information and Software Systems Engineering
George Mason University
4400 University Drive
Fairfax, VA 22030-4444
(703)993-1640, or esibley@gmuvax.gmu.edu

CALL FOR PAPERS IEEE TRANSACTIONS ON RELIABILITY

SPECIAL ISSUE ON FAULT-TOLERANT SOFTWARE

The Editorial Board of the IEEE Transactions on Reliability is planning a special issue of papers on Fault-Tolerant Software Techniques and Systems. The objective is to provide a literary forum for the exchange of information among software/hardware computer specialists, design engineers, system analysts, computer reliability/maintainability specialists, and other computer engineering professionals.

Authors are invited to submit previously unpublished papers dealing with the following suggested topics:

- Fault-Tolerant Software Architecture
- Design Techniques for Fault-Tolerant Software
- Software Design Diversity
- Experimental Analysis of Fault-Tolerant Software
- Reliability, Dependability, and Performability Evaluation of Software Fault-Tolerant Systems
- Fault-Tolerant Software System Applications
- Case Studies

Papers are solicited dealing with particulars rather than generalities of the suggested topics. Preference will be given to practical papers over purely theoretical papers.

In order to assist the board in planning the special issue, cooperation of prospective authors is solicited with the following target dates:

- Author's letter of commitment (including a brief summary) - 31 December 1991
- Submission of manuscripts (6 copies) - 30 April 1992
The first page of the manuscript should include the author's address, affiliation, telephone and FAX numbers.
- Submission of final revised manuscripts - 1 September 1992.

Letters of inquiry, letters of commitment, and manuscripts for submission, should be sent to one of the Guest Editors:

Dr. John F. Meyer
EECS Dept.
University of Michigan
Ann Arbor, MI 48109
Phone: (313) 763-0037
FAX: (313) 763-1503
E-mail jfm@eecs.umich.edu

Dr. Hoang Pham
Idaho National Engineering Laboratory
EG&G Idaho, Inc.
P.O. Box 1625, M/S 2406
Idaho Falls, ID 83415
Phone: (208) 526-9274
FAX: (208) 526-2930

RELIABILITY SOCIETY 30TH ANNUAL ALL DAY SEMINAR
 BOSTON IEEE RELIABILITY CHAPTER
 THURSDAY, APRIL 23, 1992
 SHERATON TARA, ROUTE 9, FRAMINGHAM, MA

***“Reliability Engineering: Alternative Techniques
 For Today’s Business Environment”***

In today’s business environment where sales have slowed and present budgets are tight, many companies are approaching reliability in different ways. These companies still want to produce a reliable product but have been driven to optimize the cost effectiveness of their reliability programs. This has led to new techniques and approaches for achieving high reliability for less cost. This year’s seminar seeks to present these new techniques over a diverse product range.

PAPERS TO BE PRESENTED WILL BE IN THE FOLLOWING AREAS:

- | | | |
|---------------------------|---------------------------|------------------------|
| Reliability Predictions • | | • Automotive |
| Warranties • | | • Military |
| Software Reliability • | | • Medical |
| Reliability Growth • | AS THEY RELATE TO: | • Commercial Aircraft |
| FMECA • | | • Consumer Electronics |
| CAD/CAE • | | • Computers |
| Stress Screening • | | • Aerospace |

REGISTRATION FEES: (fees include seminar, lunch, and dinner).

Prior to March 28, 1992: \$150 IEEE members, \$175 non-members

After March 28, 1992: \$175 IEEE members, \$200 non-members

NOTE: A \$25 rebate issued to non-members who join the IEEE within a reasonable time.

Make checks payable to: Reliability Chapter of Boston IEEE Section

Mail checks and registration form to: Jim Kalembo
 6 Ohio Road
 Tyngsboro, MA 01879-2365

30th ANNUAL ALL DAY RELIABILITY SEMINAR REGISTRATION FORM

Name _____ Company/Affiliation _____

Address _____ Town/City _____

State/Zip _____ Phone # _____

Amount Paid _____ Date _____ IEEE Number _____

Seminar Proceedings available after April 23th for \$15 each. Call (617) 455-3394 for further information.

CALL FOR PAPERS

1992
 Nov 4-6

IASTED

International Association of Science and
 Technology for Development

International Conference on Reliability, Quality
 Control and Risk Assessment

Washington, D.C.

Survey papers and case studies are solicited on:

- | | |
|-----------------|------------------------------------|
| • Reliability | • Fault Tolerance |
| • Human Factors | • Simulation |
| • Risk Analysis | • Software Safety |
| • Quality Costs | • Modeling |
| • Testing | • Availability and Maintainability |

Submit 3 copies (15 double spaced pages max.) by **May 1, 1992.**

Notification of acceptance/rejection by June 30, 1992.

Camera-ready papers due September 15, 1992.

Dr. Hoang Pham
 Program Chairman
 Idaho National Engineering Laboratory
 P.O. Box 1605, M/S 2406
 Idaho Falls, ID 83415
 Tel: (208)526-9274
 Fax: (208)526-2930

INTEGRATED R&M SOFTWARE FAMILY AVAILABLE FROM ONE SOURCE

Serves DOD, large and small defense and space contractors,
commercial companies, consultants and universities

Powertronic Systems Inc. provides the largest available family of R&M software that includes: Part Stress and Parts Count Reliability Prediction; Industrial and Mechanical Reliability Prediction; Failure Modes, Effects and Criticality Analysis; Maintainability Prediction; System Reliability; and Concurrent Engineering Programs. PSI programs are linked with each other and with other CAE and database programs.

The basic programs have stand-alone capability for all necessary analysis functions, and enhancements are available to expand capability for special user needs. Programs feature easy data input and manipulation, as well as the ability to generate both required and special reports.

MS-DOS versions are available now, and UNIX versions are being developed.
PSI has served users in North and South America, Europe and Asia since 1982.

Call for more information.



**POWERTRONIC
SYSTEMS, INC.**

P.O. Box 29109
New Orleans, Louisiana 70189 U.S.A.
(504) 254-0383 FAX (504) 254-0393

Solve your problem

Now with the

Reliability Toolbox

Mil-Hdbk-217, BellCore, Fault Tree Analysis,
FMECA, Weibull, Reliability Growth,
Burn-In, Design Trade-Off, Chi
Square, Regression Analysis,
Poisson Exponential, Mil-Std-781,
Mil-Std-105D, Series/Parallel/Complex System
Analysis, Warranty Program/Life Cycle Cost Planning

Computer Aided Engineering for the Reliability Engineer.
Affordable CAE/CALCE from the Price/Performance Leader.

You PICK only the tools you want from ITS' complete inventory of quality, reliability, and maintainability solutions.
ITS will then package those tools for you in a state-of-the art, integrated user friendly "software" toolbox.

Call 919-864-7705 for more details or to order a FREE
Demonstration/Catalog Diskette.

Innovative Timely Solutions
6401 Lakerest Court, Raleigh, NC 27612 919-846-7705

217F is here!

- Frustrated with the limitations of 217E and E Notice 1?
- Need to address VLSI, GaAs, VHSIC, and higher complexity technologies?
- Ready to start using more realistic failure rates than 217E provides?

Like you, we believe the 217F technology is too good to ignore any longer.

That's why REAP™, SEA's popular Reliability Analysis Software, now includes all of the MIL-HDBK-217F features.

Now you don't have to wait another minute to take advantage of the benefits MIL-HDBK-217F offers.

To order your copy of REAP 217F for as little as \$995, call SEA™ toll-free at 800-688-2003.



**SYSTEMS EFFECTIVENESS
ASSOCIATES, INC.**

20 Vernon Street
Norwood, Massachusetts 02062
Tel: 617-762-9252 • FAX: 617-769-9422

REAP and SEA are trademarks of Systems Effectiveness Associates, Inc.

**The Best Name
in Reliability Software**

Relextm

from

Innovative Software Designs, Inc.

"The Relex line provides a friendly, flexible, feature-packed environment for performing your reliability analyses."

The Relex product line is comprised of an unbeatable, comprehensive set of reliability analysis tools which are unique in their quality, ease-of-use, and flexibility. The Relex line is designed to meet all your analysis requirements and each product offers a wide range of features. Just a few notable Relex features include pull-down menus, pop-up choice lists, on-line context sensitive help, CAD interfaces, part libraries, graphical outputs, customized reports, and much, much more.

All Relex products are back by an unconditional 30-day money back guarantee, and by ISD's commitment to product quality and customer support. Discover the Relex advantage and take a step towards improved product reliability. Call for your free self-running demo disk and information packet today.

Products available from ISD include:

- ★ **Relex MIL-HDBK-217**
- ★ **Relex Bellcore**
- ★ **Relex CNET**
- ★ **Relex Mechanical**
- ★ **Relex FMECA**
- ★ **Relex MIL-HDBK-217 Parts Count**
- ★ **Relex CNET Calculs Simplifiés**
- ★ **BETAsoft-R Board Thermal Analysis**
- ★ **BETAsoft-S System Thermal Analysis**
- ★ **WeibullSMITH Probability Analysis**

Call Today For Your Free Demo Disk! (301) 747-8543



Innovative Software Designs, Inc.

One Kimball Ridge Court • Baltimore, MD 21228
(301) 747-8543 • Fax (301) 747-8599

Relex and ISD are trademarks of Innovative Software Designs, Inc.